

**IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE**

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|---------------------------------|---|-------------------------|
| In re Application of: |) | Group Art Unit: 2891 |
| Pei-Haw Tsao <i>et al.</i> |) | Examiner: Dana Farahani |
| Serial No.: |) | |
| 10/711,503 |) | |
| Filed: |) | |
| September 22, 2004 |) | |
| For: |) | |
| IC PACKAGE HAVING GROUND |) | |
| IC CHIP AND METHOD OF |) | |
| MANUFACTURING SAME |) | |

Submitted via EFS

Mail Stop: **AF**
Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

Dear Sir:

AMENDMENT UNDER 37 C.F.R. 1.116

This communication is in response to the Final Office Action of June 29, 2006.

The Applicants note that the three month deadline for filing a response to this Final Office Action is September 29, 2006; thus, this Amendment is timely and is being filed with a Request for Continued Examination.